SHIGA7.036APC PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

Applicant : Masuda et al.

Appl. No. : 10/564,510

Filed: January 12, 2006

For : POSITIVE PHOTORESIST

COMPOSITION AND METHOD

OF FORMING RESIST PATTERN

Examiner : Chu, John S Y

Group Art Unit : 1752

## AMENDMENT AND RESPONSE TO OFFICE ACTION

## Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

## Dear Sir:

In response to the Office Action mailed **July 2, 2007**, please amend the above-referenced application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.